BC847/BC547 series

45 V, 100 mA NPN general-purpose transistors

Rev. 06 — 19 May 2005

Product data sheet

1. Product profile

1.1 General description

NPN general-purpose transistors.

Table 1: Product overview

Type number [1]	Package	PNP complement	
	Philips	JEITA	
BC847	SOT23	-	BC857
BC847W	SOT323	SC-70	BC857W
BC847T	SOT416	SC-75	BC857T
BC847AM	SOT883	SC-101	BC857AM
BC847BM	SOT883	SC-101	BC857BM
BC847CM	SOT883	SC-101	BC857CM
BC547 [2]	SOT54	SC-43A	BC557

^[1] Valid for all available selection groups.

1.2 Features

- Low current
- Low voltage
- Three different gain selections

1.3 Applications

■ General-purpose switching and amplification

1.4 Quick reference data

Table 2: Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CEO}	collector-emitter voltage	open base	1-	M 301 Au	45	V
I _C	collector current (DC)		-	-	100	mA
h _{FE}	DC current gain	$V_{CE} = 5 \text{ V};$ $I_{C} = 2 \text{ mA}$	110	-	800	
	h _{FE} group A		110	180	220	
	h _{FE} group B		200	290	450	
	h _{FE} group C		420	520	800	





^[2] Also available in SOT54A and SOT54 variant packages (see Section 2).

2. Pinning information

Table 3: **Pinning** Simplified outline Pin Description **Symbol** SOT23, SOT323, SOT416 base 3 2 emitter 3 collector 1 2 sym021 006aaa144 **SOT883** 1 base 2 emitter 3 collector Transparent top view sym021 SOT54 1 emitter 2 base 3 collector 001aab347 sym026 SOT54A 1 emitter 2 base 3 collector 001aab348 sym026 **SOT54** variant emitter 2 base 3 collector

sym026

3. Ordering information

Table 4: Ordering information

Type number [1]	Package					
	Name	Description	Version			
BC847	-	plastic surface mounted package; 3 leads	SOT23			
BC847W	SC-70	plastic surface mounted package; 3 leads	SOT323			
BC847T	SC-75	plastic surface mounted package; 3 leads	SOT416			
BC847AM	SC-101	leadless ultra small plastic package; 3 solder lands;	SOT883			
BC847BM		body $1.0 \times 0.6 \times 0.5$ mm				
BC847CM	_					
BC547 [2]	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54			

^[1] Valid for all available selection groups.

4. Marking

Table 5: Marking codes

Type number	Marking code [1]	Type number	Marking code [1]
BC847	1H*	BC847AT	1E
BC847A	1E*	BC847BT	1F
BC847B	1F*	BC847CT	1G
BC847C	1G*	BC847AM	D4
BC847W	1H*	BC847BM	D5
BC847AW	1E*	BC847CM	D6
BC847BW	1F*	BC547	C547
BC847CW	1G*	BC547B	C547B
BC847T	1N	BC547C	C547C

^{[1] * = -:} made in Hong Kong

3 of 13

^[2] Also available in SOT54 and SOT54 variant packages (see Section 2 and Section 9).

^{* =} p: made in Hong Kong

^{* =} t: made in Malaysia

^{* =} W: made in China

5. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	50	V
V_{CEO}	collector-emitter voltage	open base	-	45	V
V_{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current (DC)		-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA
I _{BM}	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
	SOT23		<u>[1]</u> _	250	mW
	SOT323		<u>[1]</u> _	200	mW
	SOT416		<u>[1]</u> _	150	mW
	SOT883		[2] [3]	250	mW
	SOT54		<u>[1]</u> _	500	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 7: Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air				
	SOT23		[1] -	-	500	K/W
	SOT323		<u>[1]</u> -	-	625	K/W
	SOT416		<u>[1]</u> -	-	833	K/W
	SOT883		[2] [3]	-	500	K/W
	SOT54		<u>[1]</u> -	-	250	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

^[2] Reflow soldering is the only recommended soldering method.

^[3] Device mounted on an FR4 PCB with 60 μm copper strip line, standard footprint.

^[2] Reflow soldering is the only recommended soldering method.

^[3] Device mounted on an FR4 PCB with 60 μm copper strip line, standard footprint.

7. Characteristics

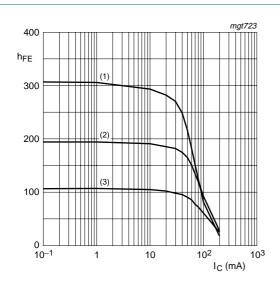
Table 8: Characteristics

 T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$		-	-	15	nΑ
	current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 ^{\circ}\text{C}$		-	-	5	μА
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{E} = 0 \text{ A}$		-	-	100	nA
h _{FE}	DC current gain						
	h _{FE} group A	$V_{CE} = 5 \text{ V}; I_{C} = 10 \mu\text{A}$		-	90	-	
	h _{FE} group B	$V_{CE} = 5 \text{ V}; I_{C} = 10 \mu\text{A}$		-	150	-	
	h _{FE} group C	$V_{CE} = 5 \text{ V}; I_{C} = 10 \mu\text{A}$		-	270	-	
	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		110	-	800	
	h _{FE} group A	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		110	180	220	
	h _{FE} group B	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		200	290	450	
	h _{FE} group C	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$		420	520	800	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$		-	90	200	mV
		$I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$	[1]	-	200	400	mV
V _{BEsat}	base-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	[2]	-	700	-	mV
		$I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$	[2]	-	900	-	mV
V_{BE}	base-emitter voltage	$I_C = 2 \text{ mA}$; $V_{CE} = 5 \text{ V}$	[2]	580	660	700	mV
		$I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V}$		-	-	770	mV
C _c	collector capacitance	$I_E = i_e = 0 A; V_{CB} = 10 V;$ f = 1 MHz		-	-	1.5	pF
C _e	emitter capacitance	$I_C = I_c = 0 \text{ A}; V_{EB} = 0.5 \text{ V};$ f = 1 MHz		-	11	-	pF
f _T	transition frequency	$I_C = 10 \text{ mA}; V_{CE} = 5 \text{ V};$ f = 100 MHz		100	-	-	MHz
F	noise figure	$I_C = 200 \mu A; V_{CE} = 5 V;$ $R_S = 2 k\Omega; f = 1 kHz;$ B = 200 Hz		-	2	10	dB

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

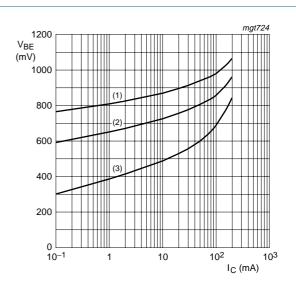
^[2] V_{BE} decreases by approximately 2 mV/K with increasing temperature.





- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

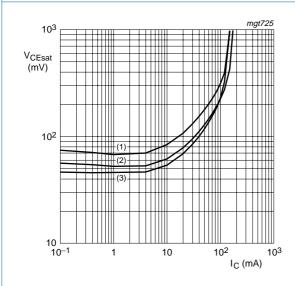
Fig 1. Selection A: DC current gain as a function of collector current; typical values



$$V_{CE} = 5 V$$

- (1) $T_{amb} = -55$ °C
- (2) T_{amb} = 25 °C
- (3) $T_{amb} = 150 \, ^{\circ}C$

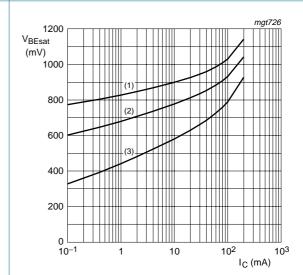
Fig 2. Selection A: Base-emitter voltage as a function of collector current; typical values





- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) T_{amb} = 25 °C
- (3) $T_{amb} = -55 \, ^{\circ}C$

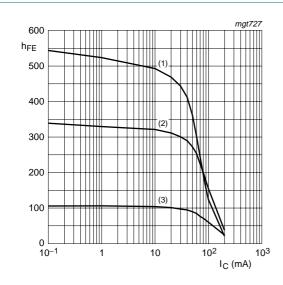
Fig 3. Selection A: Collector-emitter saturation voltage as a function of collector current; typical values



$$I_{\rm C}/I_{\rm B} = 10$$

- (1) $T_{amb} = -55$ °C
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

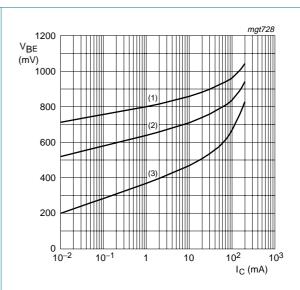
Fig 4. Selection A: Base-emitter saturation voltage as a function of collector current; typical values



$$V_{CE} = 5 V$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

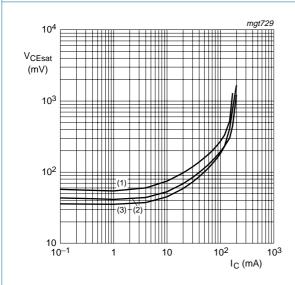
Fig 5. Selection B: DC current gain as a function of collector current; typical values



$$V_{CE} = 5 V$$

- (1) $T_{amb} = -55 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

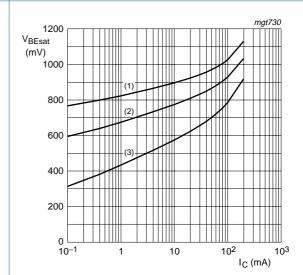
Fig 6. Selection B: Base-emitter voltage as a function of collector current; typical values





- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \,^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 7. Selection B: Collector-emitter saturation voltage as a function of collector current; typical values

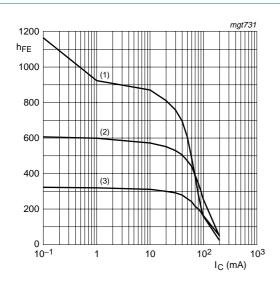


$$I_{\rm C}/I_{\rm B} = 10$$

- (1) $T_{amb} = -55$ °C
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

Fig 8. Selection B: Base-emitter saturation voltage as a function of collector current; typical values

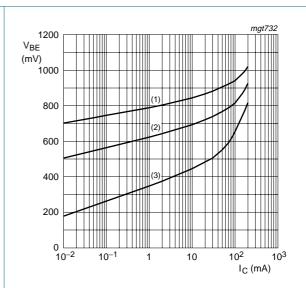
Product data sheet



$$V_{CE} = 5 \text{ V}$$

- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

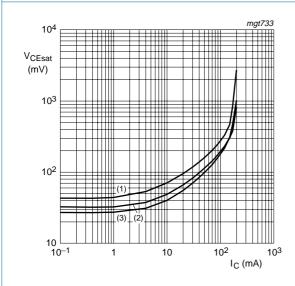
Fig 9. Selection C: DC current gain as a function of collector current; typical values



$$V_{CE} = 5 \text{ V}$$

- (1) $T_{amb} = -55 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

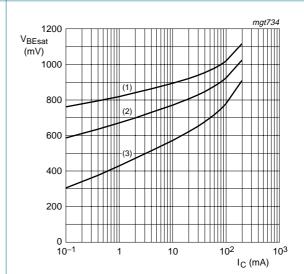
Fig 10. Selection C: Base-emitter voltage as a function of collector current; typical values





- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \,^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 11. Selection C: Collector-emitter saturation voltage as a function of collector current; typical values



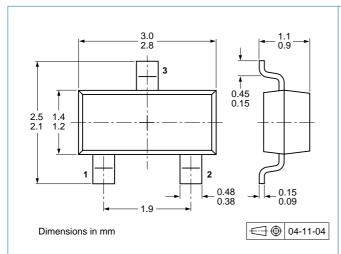
$$I_{\rm C}/I_{\rm B} = 10$$

- (1) $T_{amb} = -55$ °C
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

Fig 12. Selection C: Base-emitter saturation voltage as a function of collector current; typical values

Product data sheet

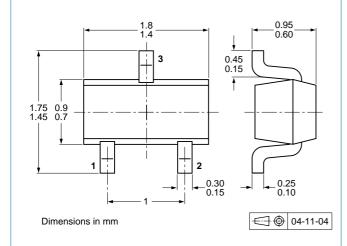
8. Package outline



2.2 1.35 2.0 1.15 2.2 1.35 2.0 1.15 0.25 0.10 Dimensions in mm

Fig 13. Package outline SOT23 (TO-236AB)

Fig 14. Package outline SOT323 (SC-70)



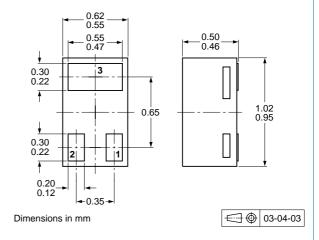
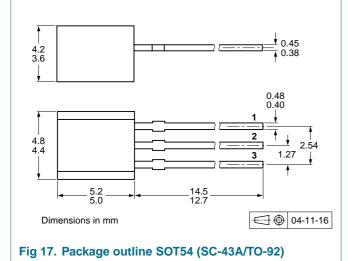


Fig 15. Package outline SOT416 (SC-75)

Fig 16. Package outline SOT883 (SC-101)



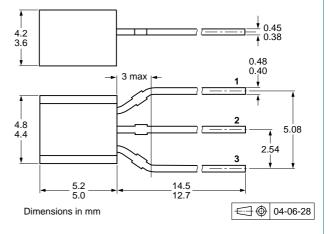
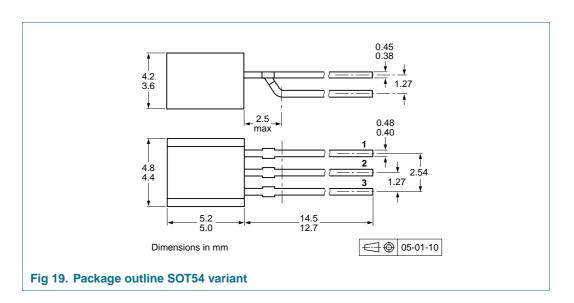


Fig 18. Package outline SOT54A



9. Packing information

Table 9: Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code. [1]

Type number [2]	Package	Description	Packing quantity		
			3000	5000	10000
BC847	SOT23	4 mm pitch, 8 mm tape and reel	-215	-	-235
BC847W	SOT323	4 mm pitch, 8 mm tape and reel	-115	-	-135
BC847T	SOT416	4 mm pitch, 8 mm tape and reel	-115	-	-135
BC847AM	SOT883	2 mm pitch, 8 mm tape and reel	-	-	-315
BC847BM	_				
BC847CM	_				
BC547	SOT54	bulk, straight leads	-	-412	-
	SOT54A	tape and reel, wide pitch	-	-	-116
		tape ammopack, wide pitch	-	-	-126
	SOT54 variant	bulk, delta pinning	-	-112	-

^[1] For further information and the availability of packing methods, see <u>Section 15</u>.

^[2] Valid for all available selection groups.

BC847/BC547 series

45 V, 100 mA NPN general-purpose transistors



Table 10: Revision history

Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
BC847_BC547_SER_6	20050519	Product data sheet	-	9397 750 14609	BC846_BC847_ BC848_5, BC847M_SERIES_2, BC846T_847T_ SERIES_3, BC846W_BC847W_ BC848W_4, BC546_547_4
Modifications:		t of this data sheet ha nation standard of Phi	•	• •	ne new presentation
	BC846_B0	sheet is a type combi C847_BC848_5, BC8 BC847W_BC848W_4	47M_SERIES_2,	BC846T_847T_SE	
BC846_BC847_BC848_5	20040206	Product specification	-	9397 750 12395	BC846_BC847_ BC848_4
BC847M_SERIES_2	20040310	Product specification	-	9397 750 12838	BC847M_SERIES_1
BC846T_847T_SERIES_3	20001115	Product specification	-	9397 750 07524	BC846T_847T_2
BC846W_BC847W_ BC848W_4	20020204	Product specification	-	9397 750 09166	BC846W_847W_3
BC546_547_4	20041125	Product specification	-	9397 750 13568	BC546_547_3



Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

- [1] Please consult the most recently issued data sheet before initiating or completing a design
- [2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- [3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

12. Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

13. Disclaimers

Life support — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors

customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes in the products - including circuits, standard cells, and/or software - described or contained herein in order to improve design and/or performance. When the product is in full production (status 'Production'), relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

14. Trademarks

Notice — All referenced brands, product names, service names and trademarks are the property of their respective owners.

15. Contact information

For additional information, please visit: http://www.semiconductors.philips.com
For sales office addresses, send an email to: sales.addresses@www.semiconductors.philips.com

Philips Semiconductors

BC847/BC547 series

45 V, 100 mA NPN general-purpose transistors

16. Contents

1	Product profile
1.1	General description
1.2	Features
1.3	Applications
1.4	Quick reference data1
2	Pinning information 2
3	Ordering information
4	Marking 3
5	Limiting values4
6	Thermal characteristics
7	Characteristics5
8	Package outline
9	Packing information
10	Revision history11
11	Data sheet status
12	Definitions
13	Disclaimers
14	Trademarks
15	Contact information



All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

